### SN5454, SN54LS54, SN7454, SN74LS54 **4-WIDE AND-OR-INVERT GATES**

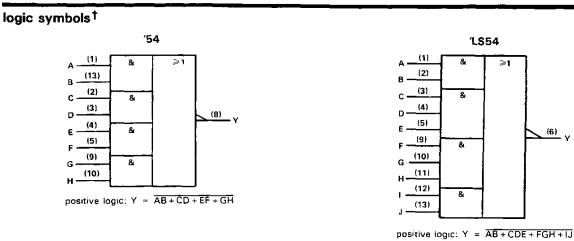
SDLS115

DECEMBER 1983-REVISED MARCH 1988

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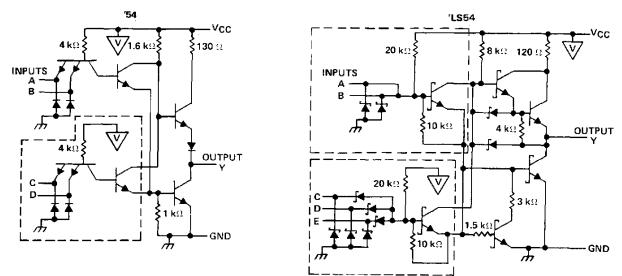
	DECEMBER 1983-REVISED
<ul> <li>Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs</li> </ul>	SN5454 J PACKAGE SN7454 N PACKAGE (TOP VIEW) A 1 1 14 VCC
<ul> <li>Dependable Texas Instruments Quality and Reliability</li> </ul>	C[2 13] B D[3 12] NU E[]4 11] NU
description	
These devices contain 4-wide AND-OR-INVERT gates. They perform the following Boolean functions:	NC[6 9]G GND[7 8]Y
$\begin{array}{rcl} 54 & Y &= \overline{AB + CD + EF + GH} \\ LS54 & Y &= \overline{AB + CDE + FGH + IJ} \end{array}$	SN5454 W PACKAGE (TOP VIEW)
The SN5454 and SN54LS54 are characterized for operation over the full military temperature range of $-55$ °C to 125 °C. The SN7454 and SN74LS54 are characterized for operation from 0 °C to 70 °C.	NU $\begin{bmatrix} 1 \\ 0 \\ 14 \end{bmatrix}$ H NU $\begin{bmatrix} 2 \\ 13 \\ 2 \end{bmatrix}$ G A $\begin{bmatrix} 3 \\ 12 \\ 14 \end{bmatrix}$ H VCC $\begin{bmatrix} 4 \\ 11 \\ 14 \end{bmatrix}$ GND B $\begin{bmatrix} 5 \\ 10 \end{bmatrix}$ NC
logic diagrams (positive logic) <sup>′54</sup>	
	SN54LS54 J OR W PACKAGE SN74LS54 D OR N PACKAGE (TOP VIEW)
	$A \  \begin{bmatrix} 1 \\ 1 \\ 4 \end{bmatrix} 14 \  \begin{bmatrix} V \\ C \\ B \\ 2 \\ 13 \\ 12 \\ 1 \\ 12 \\ 14 \\ 11 \\ 14 \\ 11 \\ 14 \\ 16 \\ 16 \\ 16$
H 'LS54	SN54LS54 FK PACKAGE (TOP VIEW)
	C 4 18 1 NC 5 17 NC D 6 16 H NC 7 15 NC
	NC-No internal connection NU-Make no external connection
PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters. Post OFFICE BOX 655012 • DALLAS. TEXAS	S 75265

### SN5454, SN54LS54, SN7454, SN74LS54 4-WIDE AND-OR-INVERT GATES



<sup>†</sup>These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, and N package. For the SN54LS54 only, they apply also for the W package.

#### schematics



Resistor values shown are nominal.

The portion of the circuits within the dashed lines is repeated for each additional 2- or 3-input AND section, as shown in the logic diagram and logic symbols.



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	7 V
Input voltage	
Operating free-air temperature: SN5454	
SN7454	0°C to 70°C
Storage temperature range	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

			SN5454			SN7454			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level input voltage	2			2			V	
VIL	Low-level input voltage			0.8	_		0.8	V .	
	High-level output current			- 0.4			- 0.4	mΑ	
IOL	Low-level output current			16			16	mA	
TA	Operating free-air temperature	- 55		125	0		70	°C	

electrical characterics over recommended operating free-air temperature range (unless otherwise noted)

		2202 40.00.2		SN5454			۱			
PARAMETER		TEST CONDIT	MIN	TYP‡	MAX	MIN	TYP‡	MAX		
VIK	V <sub>CC</sub> = MIN.	lj = 12 mA				- 1.5	[		- 1.5	V
∨он	VCC = MIN,	V <sub>IL</sub> = 0.8 V,	l <sub>QH</sub> = - 0.4 mA	2.4	3.4		2.4	3.4		V
VOL	V <sub>CC</sub> = MIN.	V <sub>1H</sub> = 2 V,	I <sub>OL</sub> = 16 mA		0.2	0.4		0.2	0.4	V
- Ij	V <sub>CC</sub> = MAX,	Vi = 5.5 V				1			1	mA
Чн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.4 V				40	Γ		40	μA
IIL.	V <sub>CC</sub> = MAX,	Vi = 0.4 V				- 1.6			- 1.6	mA
losŝ	V <sub>CC</sub> = MAX			20		- 55	- 18		- 55	mΑ
ICCH	VCC = MAX,	V   = 0 V			4	8		4	8	mA
ICCL	V <sub>CC</sub> = MAX,	See Note 2			5.1	9.5		5.1	9.5	mΑ

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

SNot more than one output should be shorted at a time.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

#### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 3)

PARAMETER	FROM (INPUT)	ТО (OUTPUT)	TEST CONDITIONS	MIN	түр	мах	UNIT
<sup>t</sup> PLH	A	, , , , , , , , , , , , , , , , , , ,	$R_1 = 400 \Omega_2$ $C_1 = 15 pF$		13	22	ns
<sup>t</sup> PHL	Апу	ſ	R <sub>L</sub> = 400 Ω, C <sub>L</sub> = 15 pF		8	15	ns –

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



### SN54LS54, SN74LS54 4-WIDE AND-OR-INVERT GATES

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note	9 1)	v
Input voltage		v
Operating free-air temperature:	SN54LS54	С
	SN74LS54 0°C to 70°C	С
Storage temperature range		с

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

		s	SN54LS54			SN74LS54			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
VIH	High-level input voltage	2			2			V	
VIL	Low-level input voltage			0.7			0.8	V	
юн	High-level output current			- 0.4			- 0.4	mA	
OL	Low-level output current			4			8	mΑ	
τ <sub>A</sub>	Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		S	N54LS5	i4	S	N74LS	54			
	1	MIN	TYP‡	MAX	MIN	TYP \$	MAX			
VIK	Vcc = MIN,	l <sub>1</sub> = 18 m A				- 1.5			- 1.5	V
∨он	V <sub>CC</sub> = MIN,	V <sub>IL</sub> = MAX,	OH = - 0.4 mA	2.5	3.4		2.7	3.4		V
VOL	V <sub>CC</sub> ≈ MIN,	V <sub>1H</sub> = 2 V,	OL=4mA		0.25	0.4		0.25	0.4	v
	V <sub>CC</sub> = MIN	V <sub>IH</sub> = 2 V,	OL = 8 mA					0.35	0.5	]
4	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V				0.1			0.1	mA
11 <u>H</u>	V <sub>CC</sub> = MAX,	VI = 2.7 V				20			20	μA
<u> <u> </u></u>	V <sub>CC</sub> = MAX,	V   = 0.4 V			_	- 0.4			- 0.4	mA
losş	V <sub>CC</sub> = MAX			- 20		- 100	- 20		- 100	mΑ
ССН	V <sub>CC</sub> = MAX,	V; = 0 V			0.8	1.6		0.8	1.6	mΑ
ICCL	V <sub>CC</sub> = MAX,	See Note 2			1	2		1	2	mΑ

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25° C.

§Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

NOTE 2: All inputs of one AND gate at 4.5 V, all others at GND.

#### switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C (see note 3)

PARAMETER	FROM (INPUT)	то (оитрит)	TEST CONDITIONS	MIN T	TYP	MAX	UNIT
t P L H	Any	v	$R_1 = 2 k\Omega, \qquad C_1 = 15 pF$		12	20	กร
<sup>t</sup> PHL		'		1	2.5	20	ពន

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.





### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN5454J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN5454J	Samples
SN54LS54J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS54J	Samples
SN54LS54J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS54J	Samples
SNJ5454J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5454J	Samples
SNJ5454J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ5454J	Samples
SNJ54LS54J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS54J	Samples
SNJ54LS54J	ACTIVE	CDIP	J	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS54J	Samples
SNJ54LS54W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS54W	Samples
SNJ54LS54W	ACTIVE	CFP	W	14	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS54W	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.



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## PACKAGE OPTION ADDENDUM

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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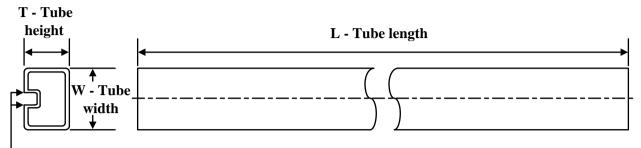
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### TEXAS INSTRUMENTS

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### TUBE



## - B - Alignment groove width

\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
SNJ54LS54W	W	CFP	14	25	506.98	26.16	6220	NA

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14



## **GENERIC PACKAGE VIEW**

# CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



# J0014A



# **PACKAGE OUTLINE**

### CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
   Falls within MIL-STD-1835 and GDIP1-T14.



## J0014A

# **EXAMPLE BOARD LAYOUT**

## CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





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